SiA426DJ

Vishay Siliconix



SPECIFICATIONS $T_J = 25 ^{\circ}\text{C}$, Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static		1000 001141110110		.,,,,		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	20			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			25		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 3.7		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	0.6		1.5	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current		V _{DS} = 20 V, V _{GS} = 0 V			1	μΑ
	IDSS	V _{DS} = 20 V, V _{GS} = 0 V, T _J = 55 °C			10	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le 5 \text{ V}, V_{GS} = 4.5 \text{ V}$		20		Α
Drain-Source On-State Resistance ^a	, ,	V _{GS} = 10 V, I _D = 9.9 A		0.0196	0.0236	Ω
	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 9.4 A		0.0219	0.0263	
	` ′	$V_{GS} = 2.5 \text{ V}, I_D = 8 \text{ A}$		0.0301	0.0361	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 10 V, I _D = 9.9 A		20		S
Dynamic ^b	<u> </u>			1		
Input Capacitance	C _{iss}			1020		
Output Capacitance	C _{oss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		160		pF
Reverse Transfer Capacitance				70		
	Q _g	V _{DS} = 10 V, V _{GS} = 10 V, I _D = 9.9 A		17.5	27	nC
Total Gate Charge				7.9	16	
Gate-Source Charge		$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 9.9 \text{ A}$		2.1		
Gate-Drain Charge	Q_{gd}			1.1		
Gate Resistance	R_{g}	f = 1 MHz	0.6	3	6	Ω
Turn-On Delay Time	t _{d(on)}			12	18	
Rise Time	t _r	$V_{DD} = 10 \text{ V}, R_{L} = 1.3 \Omega$		11	17	ns
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 7.9 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		27	41	
Fall Time	t _f			11	17	
Turn-On Delay Time	t _{d(on)}			7	14	
Rise Time	t _r	V_{DD} = 10 V, R_L = 1.3 Ω		10	15	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 7.9 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		20	30	
Fall Time	t _f			8	16	
Drain-Source Body Diode Characterist	ics					
Continuous Source-Drain Diode Current	IS	T _C = 25 °C			4.5 ^c	Α
ulse Diode Forward Current I _{SM}					20	
Body Diode Voltage	V_{SD}	$I_S = 7.9 \text{ A}, V_{GS} = 0 \text{ V}$		0.8	1.2	V
Body Diode Reverse Recovery Time	t _{rr}			16	24	ns
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 7.9 A, dl/dt = 100 A/μs, T _J = 25 °C		6	12	nC
Reverse Recovery Fall Time	t _a			7		ns
Reverse Recovery Rise Time	t _b			8		

Notes

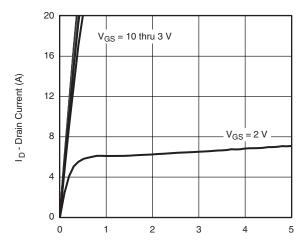
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Package Limited

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



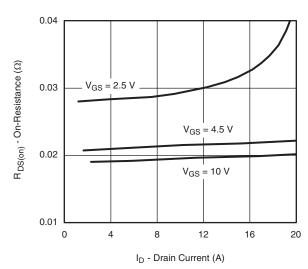
Vishay Siliconix

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

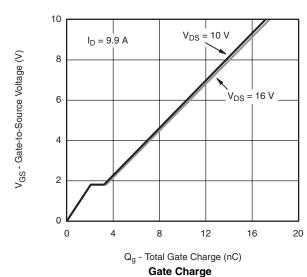


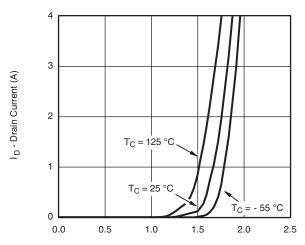
V_{DS} - Drain-to-Source Voltage (V)

Output Characteristics



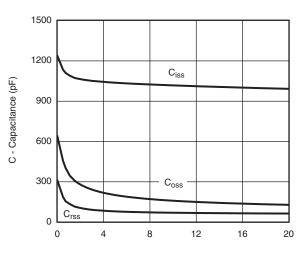
On-Resistance vs. Drain Current and Gate Voltage





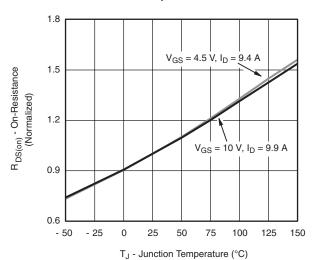
V_{GS} - Gate-to-Source Voltage (V)

Transfer Characteristics



 V_{DS} - Drain-to-Source Voltage (V)

Capacitance



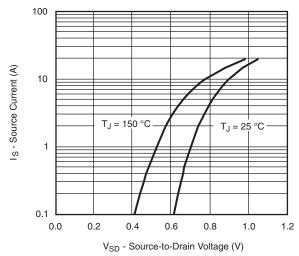
On-Resistance vs. Junction Temperature

SiA426DJ

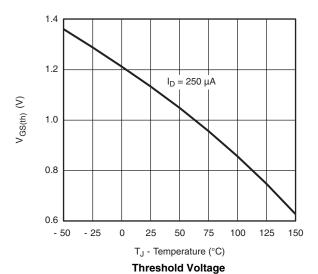
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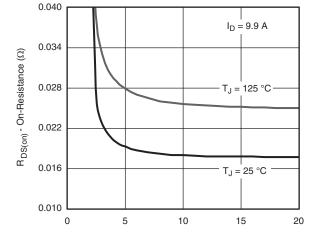
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



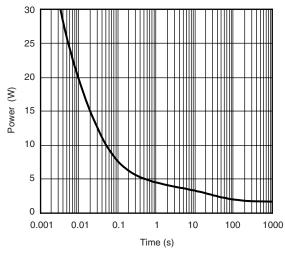
Soure-Drain Diode Forward Voltage



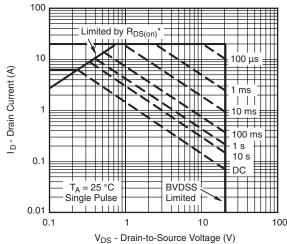


V_{GS} - Gate-to-Source Voltage (V)

On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

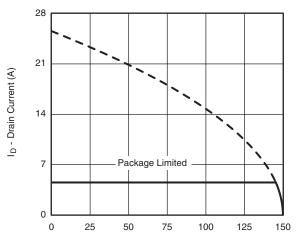


* V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

Safe Operating Area, Junction-to-Ambient

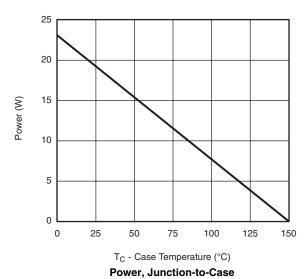
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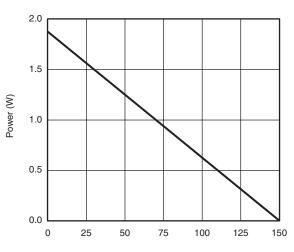
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



T_C - Case Temperature (°C)

Current Derating*





T_A - Ambient Temperature (°C)

Power, Junction-to-Ambient

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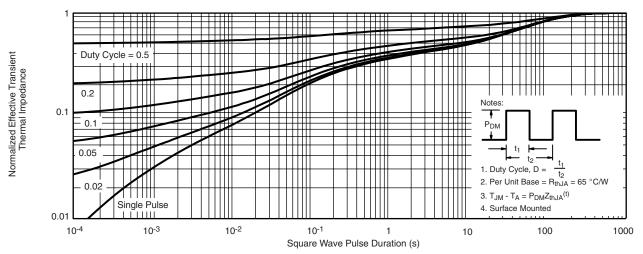
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?68630.



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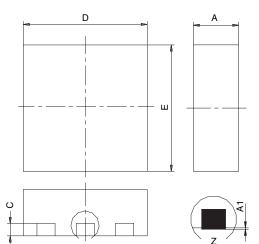
PowerPAK® SC70-6L





BACKSIDE VIEW OF SINGLE

BACKSIDE VIEW OF DUAL



- All dimensions are in millimeters
 Package outline exclusive of mold flash and metal burr
 Package outline inclusive of plating

DIM	SINGLE PAD						DUAL PAD					
	MILLIMETERS			INCHES			MILLIMETERS			INCHES		
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max
Α	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032
A 1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002
b	0.23	0.30	0.38	0.009	0.012	0.015	0.23	0.30	0.38	0.009	0.012	0.015
С	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010
D	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
D1	0.85	0.95	1.05	0.033	0.037	0.041	0.513	0.613	0.713	0.020	0.024	0.028
D2	0.135	0.235	0.335	0.005	0.009	0.013						
E	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
E1	1.40	1.50	1.60	0.055	0.059	0.063	0.85	0.95	1.05	0.033	0.037	0.041
E2	0.345	0.395	0.445	0.014	0.016	0.018						
E3	0.425	0.475	0.525	0.017	0.019	0.021						
е	0.65 BSC		0.026 BSC		0.65 BSC		0.026 BSC					
K	0.275 TYP		0.011 TYP		0.275 TYP			0.011 TYP				
K1		0.400 TYP 0.016 TYP				0.320 TYP			0.013 TYP			
K2		0.240 TYP 0.009 TYP				0.252 TYP			0.010 TYP			
К3		0.225 TYP	1	0.009 TYP								
K4	0.355 TYP 0.014 TYP											
L	0.175	0.275	0.375	0.007	0.011	0.015	0.175	0.275	0.375	0.007	0.011	0.015
Т							0.05	0.10	0.15	0.002	0.004	0.006

DETAIL Z

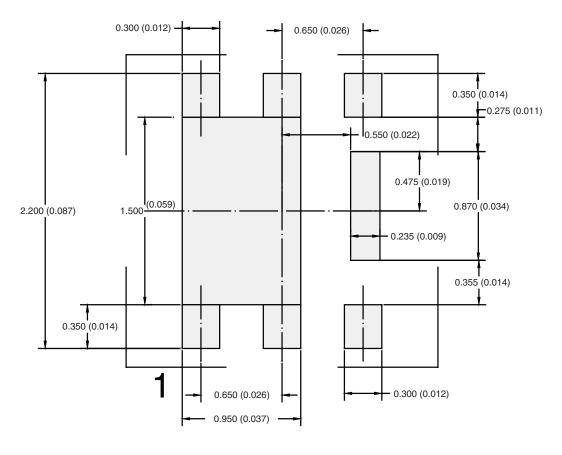
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Document Number: 73001

06-Aug-07



RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Single



Dimensions in mm/(Inches)

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